## 502908104 07/25/2014

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SHIN-JIUN KUANG	07/15/2014
TSUNG-HSING YU	07/15/2014
YI-MING SHEU	07/15/2014
CHUN-YI LEE	07/21/2014

### **RECEIVING PARTY DATA**

Name:	ame: TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.	
Street Address: NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK		
City: HSINCHU		
State/Country:	TAIWAN	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14334004

#### **CORRESPONDENCE DATA**

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DATE SIGNED:	07/25/2014

**Total Attachments: 2** 

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PATENT 502908104 REEL: 033394 FRAME: 0268

# ASSIGNMENT

WHEREAS, I(we), KUANG, SHIN-JIUN, YU, TSUNG-HSING, SHEU, YI-MING, and LEE, CHUN-YI, whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

METAL GATE STRUCTURE AND MANUFAC	CTURING METHO	OD THEREOF
(hereinafter referred to as the INVENTION) for which an application is executed on even date herewith unless at least one of the following	n for United States Lette ing is checked:	- 1 · · ·
☐ United States Design Patent was		$n_{NN}$
□ executed on:		
filed on: 17 July 2014 Serial No.:	14/334,004	
☐ established by PCT International Patent Application No.: United States of America	filed:	designating the
☐ issued on as U.S. Patent No.:		
WHEREAS, TAIWAN SEMICONDUCTOR MANUFACT address is NO.8, LI-HSIN RD. 6, HSINCHU SCIENC hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire United States and its territorial possessions;	URING COMPANY E PARK, HSINCH	U. TAIWAN, R.O.C.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we),... ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term of terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment;

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

	Assignor Name KUANG, SHIN-JIUN	RM. E, 5F., NO.1, LN. 6, CHANGCHUN ST., EAST DIST., HSINCHU CITY 300, TAIWAN (R.O.C.)
4	Signature of Assignor (X) Shin- Jihn Knang.	Date of Signature (X) > 14, 7, 15
	Name of Witness (optional)	Name of Witness (optional)
	Signature of Witness (optional)	Signature of Witness (Optional)

**PATENT REEL: 033394 FRAME: 0269** 

YU, TSUNG-HSING	6F, NO.35, LN.13, KWANGFU S. RD., TAIPEI 105, TAIWAN (R.O.C.)
Signature of Assignor (X) Name of Witness (optional)	Date of Signature (X) 7/15/2014  Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name SHEU, YI-MING	Address NO. 24, LANE 136, JUNGHE RD., HSINCHU 300, TAIWAN (R.O.C.)
Signature of Assigner (X)  Name of Winess (optional)	Date of Signature (X) Jul/15/2014  Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name LEE, CHUN-YI	NO.10-26, XIAOFENLIN, BEIPU TOWNSHIP, HSINCHU COUNTY 314, TAIWAN (R.O.C.)
Signature of Assignor (X) Lee CMM — L.  Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)